



# FFSB0665B

## THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case, Max.	$R_{\theta JC}$	2.46	C/W

## ELECTRICAL CHARACTERISTICS ( $T_J = 25\text{ C}$ unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
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### ON CHARACTERISTICS

Forward Voltage	$V_F$	$I_F = 6.0\text{ A}, T_J = 25\text{ C}$	-	1.38	1.7	V
		$I_F = 6.0\text{ A}, T_J = 125\text{ C}$	-	1.53	2.0	
		$I_F = 6.0\text{ A}, T_J = 175\text{ C}$	-	1.67	2.4	
Reverse Current	$I_R$	$V_R = 650\text{ V}, T_J = 25\text{ C}$	-	0.5	40	$\mu\text{A}$
		$V_R = 650\text{ V}, T_J = 125\text{ C}$	-	1.0	80	
		$V_R = 650\text{ V}, T_J = 175\text{ C}$	-	2.0	160	

### CHARGES, CAPACITANCES & GATE RESISTANCE

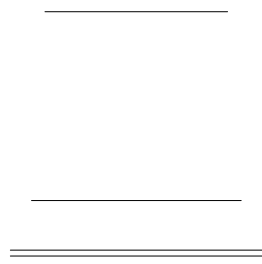
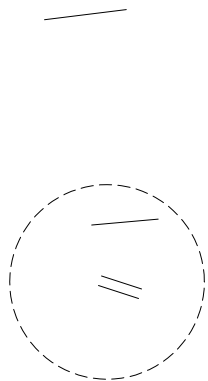
Total Capacitive Charge	$Q_C$	$V_C = 400\text{ V}$	-	16	-	nC
	$C_{tot}$	$V_R = 1\text{ V}, f = 100\text{ kHz}$	-	259	-	pF
		$V_R = 200\text{ V}, f = 100\text{ kHz}$	-	29	-	
		$V_R = 400\text{ V}, f = 100\text{ kHz}$	-	22	-	

**FFSB0665B**

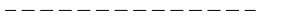


**D<sup>2</sup>PAK2 (TO-263-2L)**  
CASE 418BK  
ISSUE O

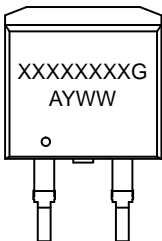
DATE 02 AUG 2018



DET/



**GENERIC  
MARKING DIAGRAM\***



- XXX = Specific Device Code
- A = Assembly Location
- Y = Year
- WW = Work Week
- G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

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